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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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OCTAL T1/E1 SHORT HAUL LINE INTERFACE UNIT

IDT82V2048

FEATURES

- Fully integrated octal T1/E1 short haul line interface which supports 100 Ω T1 twisted pair, 120 Ω E1 twisted pair and 75 Ω E1 coaxial applications
- Selectable Single Rail mode or Dual Rail mode and AMI or B8ZS/HDB3 encoder/decoder
- Built-in transmit pre-equalization meets G.703 & T1.102
- Selectable transmit/receive jitter attenuator meets ETSI CTR12/ 13, ITU G.736, G.742, G.823 and AT&T Pub 62411 specifications
- SONET/SDH optimized jitter attenuator meets ITU G.783 mapping jitter specification
- Digital/Analog LOS detector meets ITU G.775, ETS 300 233 and T1.231
- ITU G.772 non-intrusive monitoring for in-service testing for any one of channel 1 to channel 7

- Low impedance transmit drivers with high-Z
- Selectable hardware and parallel/serial host interface
- Local, Remote and Inband Loopback test functions
- Hitless Protection Switching (HPS) for 1 to 1 protection without relays
- JTAG boundary scan for board test
- 3.3 V supply with 5 V tolerant I/O
- Low power consumption
- ◆ Operating temperature range: -40°C to +85°C
- Available in 144-pin Thin Quad Flat Pack (TQFP) and 160-pin Plastic Ball Grid Array (PBGA) packages Green package options available

FUNCTIONAL BLOCK DIAGRAM

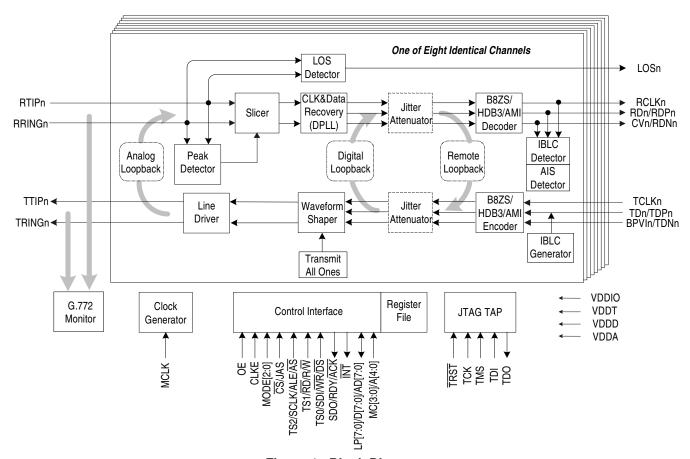


Figure-1 Block Diagram

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November 14, 2012

DESCRIPTION

The IDT82V2048 is a single chip, 8-channel T1/E1 short haul PCM transceiver with a reference clock of 1.544 MHz (T1) or 2.048 MHz (E1). The IDT82V2048 contains 8 transmitters and 8 receivers.

All the receivers and transmitters can be programmed to work either in Single Rail mode or Dual Rail mode. B8ZS/HDB3 or AMI encoder/decoder is selectable in Single Rail mode. Pre-encoded transmit data in NRZ format can be accepted when the device is configured in Dual Rail mode. The receivers perform clock and data recovery by using integrated digital phase-locked loop. As an option, the raw sliced data (no retiming) can be output on the receive data pins. Transmit equalization is implemented with low-impedance output drivers that provide shaped waveforms to the transformer, guaranteeing template conformance.

A jitter attenuator is integrated in the IDT82V2048 and can be switched into either the transmit path or the receive path for all channels. The jitter attenuation performance meets ETSI CTR12/13, ITU G.736, G.742, G.823, and AT&T Pub 62411 specifications.

The IDT82V2048 offers hardware control mode and software control mode. Software control mode works with either serial host interface or parallel host interface. The latter works via an Intel/Motorola compatible 8-bit parallel interface for both multiplexed or non-multiplexed applications. Hardware control mode uses multiplexed pins to select different operation modes when the host interface is not available to the device.

The IDT82V2048 also provides loopback and JTAG boundary scan testing functions. Using the integrated monitoring function, the IDT82V2048 can be configured as a 7-channel transceiver with non-intrusive protected monitoring points.

The IDT82V2048 can be used for SDH/SONET multiplexers, central office or PBX, digital access cross connects, digital radio base stations, remote wireless modules and microwave transmission systems.

PIN CONFIGURATIONS

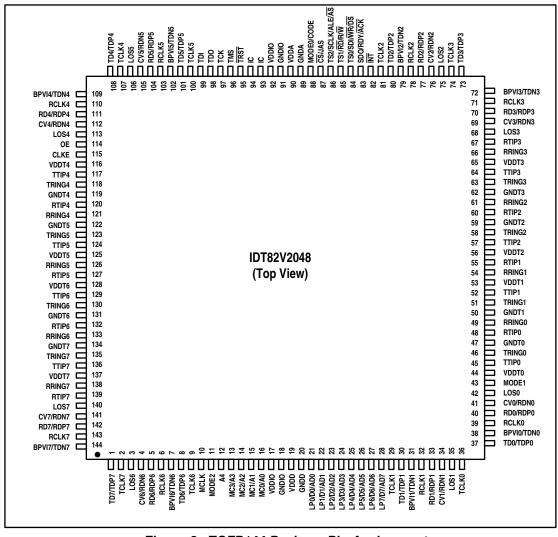


Figure-2 TQFP144 Package Pin Assignment

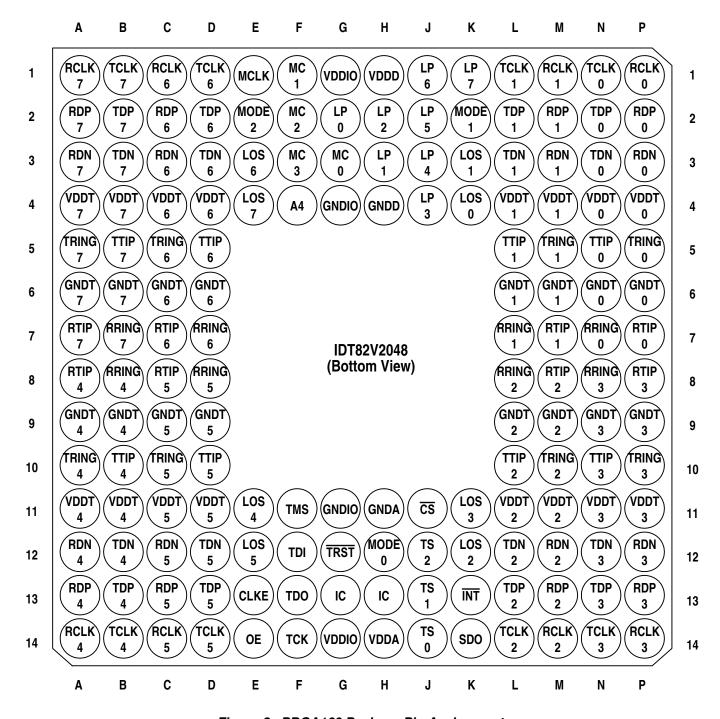


Figure-3 PBGA160 Package Pin Assignment

1 PIN DESCRIPTION

Table-1 Pin Description

Name	Туре	Pin	No.	Description	
Name	TQFP144 PBGA160		PBGA160	Description	
	•	1	l	Transmit and Receive Line Interface	
TTIP0		45	N5		
TTIP1		52	L5		
TTIP2		57	L10		
TTIP3		64 117	N10		
TTIP4			B10		
TTIP5		124	D10		
TTIP6		129	D5	TTIPn/TRINGn: Transmit Bipolar Tip/Ring for Channel 0~7	
TTIP7	Analog	136	B5	These pins are the differential line driver outputs. They will be in high-Z if pin OE is low or the correspond-	
TDINOS	Output	40	D.F.	ing pin TCLKn is low (pin OE is global control, while pin TCLKn is per-channel control). In host mode, each	
TRING0	-	46	P5 M5	pin can be in high-Z by programming a '1' to the corresponding bit in register OE (1).	
TRING1 TRING2		51 58 63 118	M10		
_			P10		
TRING3 TRING4					
TRING4		123	A10 C10		
TRING6 TRING7		130	C5 A5		
I KING/		135	Ab		
RTIP0		48	P 7		
RTIP1		55	M7		
RTIP2		60	M8		
RTIP3		67	P8		
RTIP4		120	A8		
RTIP5		127	C8		
RTIP6		132	C7		
RTIP7	Analog	139	A7	RTIPn/RRINGn: Receive Bipolar Tip/Ring for Channel 0~7	
RRING0	Input	49	N7	These pins are the differential line receiver inputs.	
RRING1		54	L7		
RRING2		61	L8		
RRING3		66	N8		
RRING4		121	B8		
RRING5		126	D8		
RRING6		133	D7		
RRING7		138	B7		

 $^{^{1}}$. Register name is indicated by bold capital letter. For example, **OE** indicates Output Enable Register.

Table-1 Pin Description (Continued)

N	Type Pin No. TQFP144 PBGA160		No.				Description		
Name			 	Description					
		•		Transmit a	nd Receive Dig	ital Data I	Interface		
TD0/TDP0 TD1/TDP1 TD2/TDP2 TD3/TDP3 TD4/TDP4 TD5/TDP5 TD6/TDP6 TD7/TDP7 BPVI0/TDN0 BPVI1/TDN1 BPVI2/TDN2 BPVI3/TDN2 BPVI3/TDN3 BPVI4/TDN4 BPVI5/TDN5 BPVI6/TDN6 BPVI7/TDN7	I	37 30 80 73 108 101 8 1 38 31 79 72 109 102 7 144	N2 L2 L13 N13 B13 D13 D2 B2 N3 L3 L12 N12 B12 D12 D3 B3	When the d sampled int rules before BPVIn: Bip Bipolar viola 14) with AM TDn the same TDPn/TDN When the d on this pin. mode is as	to the device on the being transmitt to lar Violation In the tion insertion is the enabled. A low me polarity as the enabled is in Dual Data on TDPn/T the follow: TDPn 0 0 1 1 1 TDNn high for me being transmitted.	e Rail mode the falling ed to the linsertion for available in the previous ative Transail Mode DNn are series TDNn 0 1 0 1 0 1 0 ore than 1	e, the NRZ data to be transmitted is input on this pin. Data on TDn is edges of TCLKn, and encoded by AMI or B8ZS/HDB3 line code ine. For Channel 0~7 in Single Rail mode 2 (see Table-2 on page 13 and Table-3 on page ransition on this pin will make the next logic one to be transmitted on spulse, and violate the AMI rule. This is for testing. Insmit Data for Channel 0~7 in the NRZ data to be transmitted for positive/negative pulse is input sampled on the falling edges of TCLKn. The line code in dual rail Output Pulse Space Negative Pulse Positive Pulse Space Output Pulse Output Pulse Space Output Pulse Space Output Pulse		
TCLK0 TCLK1 TCLK2 TCLK3 TCLK4 TCLK5 TCLK5	1	36 29 81 74 107 100 9 2	N1 L1 L14 N14 B14 D14 D1 B1	MCLK TCLKn Transmit Mode		or 2.048 MHz (for E1 mode) for transmit is input on this pin. The sampled into the device on the falling edges of TCLKn. MCLK cycles, the corresponding transmitter is set in Transmit Allocked). In TAOS state, the TAOS generator adopts MCLK as the insmit channel is set into power down state, while driver output ports make the maloperation insmit Allones (TAOS) signals to the line side in the corresponding smit channel. Transmit Mode mal operation insmit All Ones (TAOS) signals to the line side in the corresponding smit channel. Corresponding transmit channel is set into power down state. Kn is clocked Normal operation IKn is high Transmit All Ones (TAOS) signals to the line side in the corresponding transmit channel. Corresponding transmit channel is set into power down state. Corresponding transmit channel is set into power down state. Corresponding transmit channel is set into power down state.			

Table-1 Pin Description (Continued)

Name	Туре	Pin No.		Description	
Name	Туре	TQFP144	PBGA160	Description	
				RDn: Receive Data for Channel 0~7	
				In Single Rail mode, the received NRZ data is output on this pin. The data is decoded by AMI or B8ZS/	
RD0/RDP0		40	P2	HDB3 line code rule.	
RD1/RDP1		33	M2		
RD2/RDP2		77	M13	CVn: Code Violation for Channel 0~7	
RD3/RDP3		70	P13	In Single Rail mode, the bipolar violation, code violation and excessive zeros will be reported by driving p	
RD4/RDP4		111	A13	CVn high for a full clock cycle. However, only bipolar violation is indicated when AMI decoder is selected	
RD5/RDP5		104	C13	,	
RD6/RDP6		5	C2	RDPn/RDNn: Positive/Negative Receive Data for Channel 0~7	
RD7/RDP7	0	142	A2	In Dual Rail Mode with clock recovery, these pins output the NRZ data. A high signal on RDPn indicates	
		· ·-		the receipt of a positive pulse on RTIPn/RRINGn while a high signal on RDNn indicates the receipt of a	
CV0/RDN0	High-Z	41	P3	negative pulse on RTIPn/RRINGn.	
CV1/RDN1	111911 2	34	M3	The output data at RDn or RDPn/RDNn are clocked out on the falling edges of RCLK when the CLKE inp	
CV2/RDN2		76	M12	is low, or are clocked out on the rising edges of RCLK when CLKE is high.	
CV3/RDN3		69	P12	In Dual Rail Mode without clock recovery, these pins output the raw RZ sliced data. In this data recover	
CV4/RDN4		112	A12	mode, the active polarity of RDPn/RDNn is determined by pin CLKE. When pin CLKE is low, RDPn/RDN	
CV4/RDN4 CV5/RDN5		105	C12	is active low. When pin CLKE is high, RDPn/RDNn is active high.	
CV6/RDN6		4	C3	In hardware mode, RDn or RDPn/RDNn will remain active during LOS. In host mode, these pins will eith	
CV7/RDN7		141	A3	remain active or insert alarm indication signal (AIS) into the receive path, determined by bit AISE in regi	
CVI/NDINI		141	AS	ter GCF.	
				RDn or RDPn/RDNn is set into high-Z when the corresponding receiver is powered down.	
RCLK0		39	P1		
RCLKI		39	M1	RCLKn: Receive Clock for Channel 0-7	
RCLK1		78	M14	In clock recovery mode, this pin outputs the recovered clock from signal received on RTIPn/RRINGn. The	
RCLK2	0	71	P14	received data are clocked out of the device on the rising edges of RCLKn if pin CLKE is high, or on fallir	
RCLK4		110	A14	edges of RCLKn if pin CLKE is low.	
RCLK5	High-Z	103	C14	In data recovery mode, RCLKn is the output of an internal exclusive OR (XOR) which is connected with	
RCLK6		6	C14	RDPn and RDNn. The clock is recovered from the signal on RCLKn.	
RCLK6		143	A1	If Receiver n is powered down, the corresponding RCLKn is in high-Z.	
NULK/		143	AI		
				MCLK: Master Clock This is an independent free running reference clock. A clock of 1.544 MHz (for T1 mode) or 2.049 MHz.	
				This is an independent, free running reference clock. A clock of 1.544 MHz (for T1 mode) or 2.048 MHz (for E1 mode) is supplied to this pin as the clock reference of the device for normal operation.	
				In receive path, when MCLK is high, the device slices the incoming bipolar line signal into RZ pulse (Da	
MCLK		10	E1	Recovery mode). When MCLK is low, all the receivers are powered down, and the output pins RCLKn,	
WICLK	1	10	_ <u>-</u> 1	RDPn and RDNn are switched to high-Z.	
				In transmit path, the operation mode is decided by the combination of MCLK and TCLKn (see TCLKn pi	
				description for details).	
				NOTE: Wait state generation via RDY/ACK is not available if MCLK is not provided.	
LOS0		42	K4	<u> </u>	
LOS1		35	K3	LOSn: Loss of Signal Output for Channel 0~7	
LOS1		75	K12	A high level on this pin indicates the loss of signal when there is no transition over a specified period of	
LOS2 LOS3		68	K12	time or no enough ones density in the received signal. The transition will return to low automatically who	
LOS3 LOS4	0		E11	there is enough transitions over a specified period of time with a certain ones density in the received significant to the control of the con	
		113		nal. The LOS assertion and desertion criteria are described in 2.4.4 Loss of Signal (LOS) Detection.	
LOS5		106	E12		
LOS6		3	E3 E4		
LOS7		140	=4		

Table-1 Pin Description (Continued)

N	Туре	Pin	No.	December 1 and 1 a			
Name	Туре	TQFP144	PBGA160		Description		
	L	I.		Hardware/Host Control In	terface		
				MODE2: Control Mode Select 2			
				The signal on this pin determines	which control mode is selected to control the device:		
				MODE2	Control Interface		
				Low	Hardware Mode		
				VDDIO/2	Serial Host Interface		
				High	Parallel Host Interface		
	ı			Hardware control pins include MC	DE[2:0], TS[2:0], LP[7:0], CODE, CLKE, JAS and OE.		
MODE2		11	E2	Serial host Interface pins include			
WODEZ	(Pulled to	''	EZ		\overline{CS} , A[4:0], D[7:0], $\overline{WR}/\overline{DS}$, $\overline{RD}/R/\overline{W}$, ALE/ \overline{AS} , \overline{INT} and RDY/ \overline{ACK} . The		
	VDDIO/2)				nost interface as follows (refer to MODE1 and MODE0 pin descriptions		
				below for details):			
				MODE[2:0]	Host Interface		
				100	Non-multiplexed Motorola Mode Interface		
				101	Non-multiplexed Intel Mode Interface		
				110	Multiplexed Motorola Mode Interface		
				111	Multiplexed Intel Mode Interface		
MODE1 MODE0/CODE	I	43 88	H12	In parallel host mode, the parallel interface operates with separate address bus and data bus when this pin is low, and operates with multiplexed address and data bus when this pin is high. In serial host mode or hardware mode, this pin should be grounded. MODE0: Control Mode Select 0 In parallel host mode, the parallel host interface is configured for Motorola compatible hosts when this pin is low, or for Intel compatible hosts when this pin is high. CODE: Line Code Rule Select In hardware control mode, the B8ZS (for T1 mode)/HDB3 (for E1 mode) encoder/decoder is enabled when this pin is low, and AMI encoder/decoder is enabled when this pin is high. The selections affect all the channels. In serial host mode, this pin should be grounded.			
<u>CS</u> /JAS	I (Pulled to VDDIO/2)	87	J11	CS: Chip Select (Active Low) In host mode, this pin is asserted low by the host to enable host interface. A high to low transition must occur on this pin for each read/write operation and the level must not return to high until the operation is over. JAS: Jitter Attenuator Select In hardware control mode, this pin globally determines the Jitter Attenuator position: JAS Jitter Attenuator (JA) Configuration Low JA in transmit path VDDIO/2 JA not used High JA in receive path			
				111 1			

Table-1 Pin Description (Continued)

Nama	Type	Pin	No.	Description
Name	Туре	TQFP144	PBGA160	Description
TS2/SCLK/ ALE/AS	I	86	J12	In hardware control mode, the signal on this pin is the most significant bit for the transmit template select. Refer to 2.5.1 Waveform Shaper for details. SCLK: Shift Clock In serial host mode, the signal on this pin is the shift clock for the serial interface. Data on pin SDO is clocked out on falling edges of SCLK if pin CLKE is high, or on rising edges of SCLK if pin CLKE is low. Data on pin SDI is always sampled on rising edges of SCLK. ALE: Address Latch Enable In parallel Intel multiplexed host mode, the address on AD[4:0] is sampled into the device on the falling edges of ALE (signals on AD[7:5] are ignored). In non-multiplexed host mode, ALE should be pulled high. AS: Address Strobe (Active Low) In parallel Motorola multiplexed host mode, the address on AD[4:0] is latched into the device on the falling edges of AS (signals on AD[7:5] are ignored). In non-multiplexed host mode, AS should be pulled high.
TS1/RD/R/W	ı	85	J13	TS1: Template Select 1 In hardware control mode, the signal on this pin is the second most significant bit for the transmit template select. Refer to 2.5.1 Waveform Shaper for details. \(\overline{RD}: Read Strobe (Active Low) \) In parallel Intel multiplexed or non-multiplexed host mode, this pin is active low for read operation. R(\overline{W}: Read/Write Select \) In parallel Motorola multiplexed or non-multiplexed host mode, the pin is active low for write operation and high for read operation.
TS0/SDI/WR/ DS	I	84	J14	In hardware control mode, the signal on this pin is the least significant bit for the transmit template select. Refer to 2.5.1 Waveform Shaper for details. SDI: Serial Data Input In serial host mode, this pin input the data to the serial interface. Data on this pin is sampled on the rising edges of SCLK. WR: Write Strobe (Active Low) In parallel Intel host mode, this pin is active low during write operation. The data on D[7:0] (in non-multiplexed mode) or AD[7:0] (in multiplexed mode) is sampled into the device on the rising edges of WR. DS: Data Strobe (Active Low) In parallel Motorola host mode, this pin is active low. During a write operation (RW = 0), the data on D[7:0] (in non-multiplexed mode) or AD[7:0] (in multiplexed mode) is sampled into the device on the rising edges of DS. During a read operation (R/W = 1), the data is driven to D[7:0] (in non-multiplexed mode) or AD[7:0] (in multiplexed mode) by the device on the rising edges of DS. In parallel Motorola non-multiplexed host mode, the address information on the 5 bits of address bus A[4:0] are latched into the device on the falling edges of DS.

Table-1 Pin Description (Continued)

Name	T	Pin No.		Decembritan			
Name	Туре	TQFP144	PBGA160	Description			
SDO/RDY/ACK	0	83	K14	In serial host mode, the data is output on this pin. In serial write operation, SDO is in high impedance for the first 8 SCLK clock cycles and driven low for the remaining 8 SCLK clock cycles. In serial read operation, SDO is in high-Z only when SDI is in address/command byte. Data on pin SDO is clocked out of the device on the falling edges of SCLK if pin CLKE is high, or on the rising edges of SCLK if pin CLKE is low. RDY: Ready Output In parallel Intel host mode, the high level of this pin reports to the host that bus cycle can be completed, while low reports the host must insert wait states. ACK: Acknowledge Output (Active Low) In parallel Motorola host mode, the low level of this pin indicates that valid information on the data bus is ready for a read operation or acknowledges the acceptance of the written data during a write operation.			
ĪNT	O Open Drain	82	K13	INT: Interrupt (Active Low) This is an open drain, active low interrupt output. Four sources may cause the interrupt . Refer to 2.19 Interrupt Handling for details.			
LP7/D7/AD7 LP6/D6/AD6 LP5/D5/AD5 LP4/D4/AD4 LP3/D3/AD3 LP2/D2/AD2 LP1/D1/AD1 LP0/D0/AD0	I/O High-Z	28 27 26 25 24 23 22 21	K1 J1 J2 J3 J4 H2 H3 G2	Interrupt Handling for details. LPn: Loopback Select 7~0 In hardware control mode, pin LPn configures the corresponding channel in different loopback mode, as follows: LPn Loopback Configuration Low Remote Loopback VDDIO/2 No loopback High Analog Loopback Refer to 2.17 Loopback Mode for details. Dn: Data Bus 7~0 In non-multiplexed host mode, these pins are the bi-directional data bus. ADn: Address/Data Bus 7~0 In multiplexed host mode, these pins are the multiplexed bi-directional address/data bus. In serial host mode, these pins should be grounded.			

Table-1 Pin Description (Continued)

Nama	Time	Pin	No.	Decembrian			
Name	Туре	TQFP144	PBGA160	Description			
A4 MC3/A3 MC2/A2 MC1/A1 MC0/A0	I	12 13 14 15 16	F4 F3 F2 F1 G3	MCn: Performance Monitor Configuration 3-0 In hardware control mode, A4 must be connected to GND. MC[3:0] are used to select one transmitter or receiver of channel 1 to 7 for non-intrusive monitoring. Channel 0 is used as the monitoring channel. If a transmitter is monitored, signals on the corresponding pins TTIPn and TRINGn are internally transmitted to RTIP0 and RRING0. If a receiver is monitored, signals on the corresponding pins RTIPn and RRINGn are internally transmitted to RTIP0 and RRING0. The monitored is then output to RDP0 and RDN0 pins. In host mode operation, the signals monitored by channel 0 can be routed to TTIP0/RING0 by activating the remote loopback in this channel. Refer to 2.20 G.772 Monitoring for more details. Performance Monitor Configuration determined by MC[3:0] is shown below. Note that if MC[2:0] = 000, the device is in normal operation of all the channels. MC[3:0] Monitoring Configuration 0000 Normal operation without monitoring 0001 Monitor Receiver 1 0010 Monitor Receiver 3 0100 Monitor Receiver 3 0100 Monitor Receiver 4 0101 Monitor Receiver 5 0111 Monitor Receiver 6 0111 Monitor Receiver 7 1000 Normal operation without monitoring 1001 Monitor Transmitter 1 1010 Monitor Transmitter 2 1011 Monitor Transmitter 2 1011 Monitor Transmitter 3 1100 Monitor Transmitter 5 1110 Monitor Transmitter 6 1111 Monitor Transmitter 6 1111 Monitor Transmitter 6 1111 Monitor Transmitter 7			
OE	1	114	E14	OE: Output Driver Enable Pulling this pin low can drive all driver output into high-Z for redundancy application without external mechanical relays. In this condition, all other internal circuits remain active.			
CLKE	I	115	E13	CLKE: Clock Edge Select The signal on this pin determines the active edge of RCLKn and SCLK in clock recovery mode, or determines the active level of RDPn and RDNn in the data recovery mode. See 2.3 Clock Edges on page 14 for details.			
				JTAG Signals			
TRST	I Pull-up	95	G12	TRST: JTAG Test Port Reset (Active Low) This is the active low asynchronous reset to the JTAG Test Port. This pin has an internal pull-up resistor and it can be left open.			
TMS	I Pull-up	96	F11	TMS: JTAG Test Mode Select The signal on this pin controls the JTAG test performance and is clocked into the device on the rising edges of TCK. This pin has an internal pull-up resistor and it can be left open.			
тск	I	97	F14	TCK: JTAG Test Clock This pin input the clock of the JTAG Test. The data on TDI and TMS are clocked into the device on the rising edges of TCK, while the data on TDO is clocked out of the device on the falling edges of TCK. This pin should be connected to GNDIO or VDDIO pin when unused.			

Table-1 Pin Description (Continued)

Massa	T	Pin	No.	Provident	
Name	TQFP144 PBGA160		PBGA160	Description	
TDO	O High-Z	98	F13	TDO: JTAG Test Data Output This pin output the serial data of the JTAG Test. The data on TDO is clocked out of the device on the fa ing edges of TCK. TDO is a high-Z output signal. It is active only when scanning of data is out. This pin should be left float when unused.	
TDI	l Pull-up	99	F12	TDI: JTAG Test Data Input This pin input the serial data of the JTAG Test. The data on TDI is clocked into the device on the rising edges of TCK. This pin has an internal pull-up resistor and it can be left open.	
	I	l	L	Power Supplies and Grounds	
VDDIO	-	17 92	G1 G14	3.3 V I/O Power Supply	
GNDIO	-	18 91	G4 G11	I/O GND	
VDDT0 VDDT1 VDDT2 VDDT3 VDDT4 VDDT5 VDDT6 VDDT7	-	44 53 56 65 116 125 128 137	N4, P4 L4, M4 L11, M11 N11, P11 A11, B11 C11, D11 C4, D4 A4, B4	3.3 V/5 V Power Supply for Transmitter Driver All VDDT pins must be connected to 3.3 V or all VDDT must be connected to 5 V. It is not allowed to leave any of the VDDT pins open (not-connected) even if the channel is not used. T1 is only 5V VDDT.	
GNDT0 GNDT1 GNDT2 GNDT3 GNDT4 GNDT5 GNDT6 GNDT7	-	47 50 59 62 119 122 131 134	N6, P6 L6, M6 L9, M9 N9, P9 A9, B9 C9, D9 C6, D6 A6, B6	Analog GND for Transmitter Driver	
VDDD VDDA	-	19 90	H1 H14	3.3 V Digital/Analog Core Power Supply	
GNDD GNDA	-	20 89	H4 H11	Digital/Analog Core GND	
	•	•	•	Others	
IC	0	93 94	G13 H13	IC: Internal Connection Internal use. Leave it float for normal operation.	

2 FUNCTIONAL DESCRIPTION

2.1 OVERVIEW

The IDT82V2048 is a fully integrated octal short-haul line interface unit, which contains eight transmit and receive channels for use in either T1 or E1 applications. The receiver performs clock and data recovery. As an option, the raw sliced data (no retiming) can be output to the system. Transmit equalization is implemented with low-impedance output drivers that provide shaped waveforms to the transformer, guaranteeing template conformance. A selectable jitter attenuator may be placed in the receive path or the transmit path. Moreover, multiple testing functions, such as error detection, loopback and JTAG boundary scan are also provided. The device is optimized for flexible software control through a serial or parallel host mode interface. Hardware control is also available. Figure-1 on page 1 shows one of the eight identical channels operation.

2.2 T1/E1 MODE SELECTION

T1/E1 mode selection configures the device globally. In Hardware Mode, the template selection pins TS[2:0], determine whether the operation mode is T1 or E1 (see Table-9 on page 19). In Software Mode, the register **TS** determines whether the operation mode is T1 or E1.

2.2.1 SYSTEM INTERFACE

The system interface of each channel can be configured to operate in different modes:

- 1. Single rail interface with clock recovery.
- 2. Dual rail interface with clock recovery.
- 3. Dual rail interface with data recovery (that is, with raw data slicing only and without clock recovery).

Each signal pin on system side has multiple functions depending on which operation mode the device is in.

The Dual Rail interface consists of TDPn¹, TDNn, TCLKn, RDPn, RDNn and RCLKn. Data transmitted from TDPn and TDNn appears on TTIPn and TRINGn at the line interface; data received from the RTIPn and RRINGn at the line interface are transferred to RDPn and RDNn while the recovered clock extracting from the received data stream outputs on RCLKn. In Dual Rail operation, the clock/data recovery mode is selectable. Dual Rail interface with clock recovery shown in Figure-4 is a default configuration mode. Dual Rail interface with data recovery is shown in Figure-5. Pin RDPn and RDNn, are raw RZ slice outputs and internally connected to an EXOR which is fed to the RCLKn output for external clock recovery applications.

In Single Rail mode, data transmitted from TDn appears on TTIPn and TRINGn at the line interface. Data received from the RTIPn and RRINGn at the line interface appears on RDn while the recovered clock extracting from the received data stream outputs on RCLKn. When the device is in single rail interface, the selectable AMI or B8ZS/HDB3 line encoder/decoder is available and any code violation in the received data will be indicated at the CVn pin. The Single Rail mode has 2 sub-modes: Single Rail Mode 1 and Single Rail Mode 2. Single Rail Mode 1, whose interface is composed of TDn, TCLKn, RDn, CVn and RCLKn, is realized by pulling pin TDNn high for more than 16 consecutive TCLK cycles. Single Rail Mode 2, whose interface is composed of TDn, TCLKn, RDn, CVn, RCLKn and BPVIn, is realized by setting bit CRS in register e-CRS² and bit SING in register e-SING. The difference between them is that, in the latter mode bipolar violation can be inserted via pin BPVIn if AMI line code is selected.

The configuration of the Hardware Mode System Interface is summarized in Table-2. The configuration of the Host Mode System Interface is summarized in Table-3.

² The first letter 'e-' indicates expanded register.

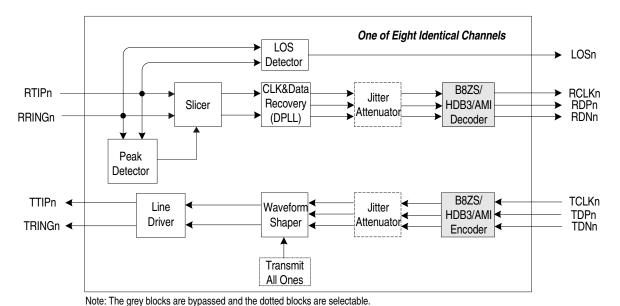
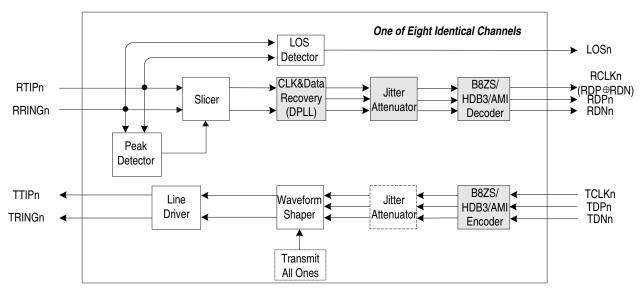


Figure-4 Dual Rail Interface with Clock Recovery

^{1.} The footprint 'n' (n = 0 - 7) indicates one of the eight channels.



Note: The grey blocks are bypassed and the dotted blocks are selectable.

Figure-5 Dual Rail Interface with Data Recovery

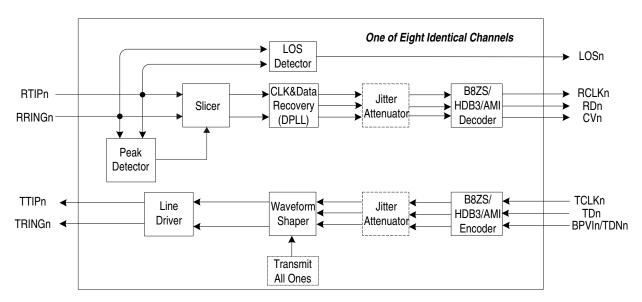


Figure-6 Single Rail Mode

Table-2 System Interface Configuration (In Hardware Mode)

Pin MCLK	Pin TDNn	Interface
Clocked	High (≥ 16 MCLK)	Single Rail Mode 1
Clocked	Pulse	Dual Rail mode with Clock Recovery
High	Pulse	Dual Rail mode with Data Recovery. Receive just slices the incoming data. Transmit is determined by the status of TCLKn.
Low	Pulse	Receiver is powered down. Transmit is determined by the status of TCLKn.

Table-3 System Interface Configuration (In Host Mode)

Pin MCLK	Pin TDNn	CRSn in e-CRS	SINGn in e-SING	Interface
Clocked	High	0	0	Single Rail Mode 1
Clocked	Pulse	0	1	Single Rail Mode 2
Clocked	Pulse	0	0	Dual Rail mode with Clock Recovery
Clocked	Pulse	1	0	Dual Rail mode with Data Recovery. Receive just slices the incoming data. Transmit is determined by the status of TCLKn.
High	Pulse	-	-	Dual Rail mode with Data Recovery. Receive just slices the incoming data. Transmit is determined by the status of TCLKn.
Low	Pulse	-	-	Receiver is powered down. Transmit is determined by the status of TCLKn.

Table-4 Active Clock Edge and Active Level

Pin CLKE	Pin RDn/F	RDPn and CVn/RDN	٧n	Pin SDO		
FIII CERE	Clock Recove	ery	Slicer Output			
High	RCLKn	Active High	Active High	SCLK	Active High	
Low	RCLKn	Active High	Active Low	SCLK	Active High	

2.3 CLOCK EDGES

The active edge of RCLKn and SCLK are selectable. If pin CLKE is high, the active edge of RCLKn is the rising edge, as for SCLK, that is falling edge. On the contrary, if CLKE is low, the active edge of RCLK is the falling edge and that of SCLK is rising edge. Pins RDn/RDPn, CVn/RDNn and SDO are always active high, and those output signals are clocked out on the active edge of RCLKn and SCLK respectively. See Table-4 Active Clock Edge and Active Level on page 14 for details. However, in dual rail mode without clock recovery, pin CLKE is used to set the active level for RDPn/RDNn raw slicing output: High for active high polarity and low for active low. It should be noted that data on pin SDI are always active high and are sampled on the rising edges of SCLK. The data on pin TDn/TDPn or BPVIn/TDNn are also always active high but are sampled on the falling edges of TCLKn, despite the level on CLKE.

2.4 RECEIVER

In receive path, the line signals couple into RRINGn and RTIPn via a transformer and are converted into RZ digital pulses by a data slicer. Adaptation for attenuation is achieved using an integral peak detector that sets the slicing levels. Clock and data are recovered from the received RZ digital pulses by a digital phase-locked loop that provides jitter accommodation. After passing through the selectable jitter attenuator, the recovered data are decoded using B8ZS/HDB3 or AMI line code rules and clocked out of pin RDn in single rail mode, or presented on RDPn/RDNn in an undecoded dual rail NRZ format. Loss of signal, alarm indication signal, line code violation and excessive zeros are detected. The presence of programmable inband loopback codes are also detected. These various changes in status may be enabled to generate interrupts.

2.4.1 PEAK DETECTOR AND SLICER

The slicer determines the presence and polarity of the received pulses. In data recovery mode, the raw positive slicer output appears on RDPn while the negative slicer output appears on RDNn. In clock and data recovery mode, the slicer output is sent to Clock and Data Recovery circuit for abstracting retimed data and optional decoding. The slicer circuit has a built-in peak detector from which the slicing threshold is derived. The slicing threshold is default to 50% (typical) of the peak value.

Signals with an attenuation of up to 12 dB (from 2.4 V) can be recovered by the receiver. To provide immunity from impulsive noise, the peak detectors are held above a minimum level of 0.150 V typically, despite the received signal level.

2.4.2 CLOCK AND DATA RECOVERY

The Clock and Data Recovery is accomplished by Digital Phase Locked Loop (DPLL). The DPLL is clocked 16 times of the received clock rate, i.e. 24.704 MHz in T1 mode or 32.768 MHz in E1 mode. The recovered data and clock from DPLL is then sent to the selectable Jitter Attenuator or decoder for further processing.

The clock recovery and data recovery mode can be selected on a per channel basis by setting bit CRSn in register **e-CRS**. When bit CRSn is defaulted to '0', the corresponding channel operates in data and clock recovery mode. The recovered clock is output on pin RCLKn and retimed NRZ data are output on pin RDPn/RDNn in dual rail mode or on RDn in single rail mode. When bit CRSn is set to '1', dual rail mode with data recovery is enabled in the corresponding channel and the clock recovery is bypassed. In this condition, the analog line signals are converted to RZ digital bit streams on the RDPn/RDNn pins and internally connected to an EXOR which is fed to the RCLKn output for external clock recovery applications.

If MCLK is pulled high, all the receivers will enter the dual rail mode with data recovery. In this case, register **e-CRS** is ignored.

2.4.3 B8ZS/HDB3/AMI LINE CODE RULE

Selectable B8ZS/HDB3 and AMI line coding/decoding is provided when the device is configured in single rail mode. B8ZS rules for T1 and HDB3 rules for E1 are enabled by setting bit CODE in register **GCF** to '0' or pulling pin CODE low. AMI rule is enabled by setting bit CODE in register **GCF** to '1' or pulling pin CODE high. The settings affect all eight channels.

Individual line code rule selection for each channel, if needed, is available by setting bit SINGn in register **e-SING** to '1' (to activate bit CODEn in register **e-CODE**) and programming bit CODEn to select line code rules in the corresponding channel: '0' for B8ZS/HDB3, while '1' for AMI. In this case, the value in bit CODE in register **GCF** or pin CODE for global control is unaffected in the corresponding channel and only affect in other channels.

In dual rail mode, the decoder/encoder are bypassed. Bit CODE in register **GCF**, bit CODEn in register **e-CODE** and pin CODE are ignored.

The configuration of the line code rule is summarized in Table-5.

2.4.4 LOSS OF SIGNAL (LOS) DETECTION

The Loss of Signal Detector monitors the amplitude and density of the received signal on receiver line before the transformer (measured on port A, B shown in Figure-14). The loss condition is reported by pulling pin LOSn high. At the same time, LOS alarm registers track LOS condition. When LOS is detected or cleared, an interrupt will generate if not masked. In host mode, the detection supports the ANSI T1.231 for T1 mode, ITU G.775 and ETSI 300 233 for E1 mode. In hardware mode, it supports the ITU G.775 and ANSI T1.231.

Table-6 summarizes the conditions of LOS in clock recovery mode.

During LOS, the RDPn/RDNn continue to output the sliced data when bit AISE in register **GCF** is set to '0' or output all ones as AIS (alarm indication signal) when bit AISE is set to '1'. The RCLKn is replaced by MCLK only if the bit AISE is set.

Table-5 Configuration of the Line Code Rule

Hardware Mode				
CODE	Line Code Rule			
Low	All channels in B8ZS/HDB3			
High	All channels in AMI			

Host Mode							
CODE in GCF	CODEn in e-CODE	SINGn in e-SING	Line Code Rule				
0	0/1	0	All channels in B8ZS/HDB3				
0	0	1	7 (iii charineis iii Bozo/11BBo				
1	0/1	0	All channels in AMI				
1	1	1	- All Charlineis III Alvii				
0	1	1	CHn in AMI				
1	0	1	CHn in B8ZS/HDB3				

Table-6 LOS Condition in Clock Recovery Mode

		Standard					
		ANSI T1.231 for T1	G.775 for E1	ETSI 300 233 for E1	LOSn		
LOS	Continuous Intervals	175	32	2048 (1 ms)	High		
Detected	Amplitude ⁽¹⁾	below typical 200 mVp	below typical 200 mVp	below typical 200 mVp	riigii		
LOS Cleared	Density 12.5% (16 marks in a sliding 128-bit period) with no more than 99 continuous zeros		12.5% (4 marks in a sliding 32-bit period) with no more than 15 continuous zeros	12.5% (4 marks in a sliding 32-bit period) with no more than 15 continuous zeros	Low		
	Amplitude ⁽¹⁾	exceed typical 250 mVp	exceed typical 250 mVp	exceed typical 250 mVp			

^{1.} LOS levels at device (RTIPn, RRINGn) with all ones signal. For more detail regarding the LOS parameters, please refer to Receiver Characteristics on page 49.

2.4.5 ALARM INDICATION SIGNAL (AIS) DETECTION

Alarm Indication Signal is available only in host mode with clock recovery, as shown in Table-7.

2.4.6 ERROR DETECTION

The device can detect excessive zeros, bipolar violation and B8ZS/HDB3 code violation, as shown in Figure-7, Figure-8 and Figure-9. In host mode, the **e-CZER** and **e-CODV** are used to determine whether

excessive zeros and code violation are reported respectively. When the device is configured in AMI decoding mode, only bipolar violation can be reported.

The error detection is available only in single rail mode in which the pin CVn/RDNn is used as error report output (CVn pin).

The configuration and report status of error detection are summarized in Table-8.

Table-7 AIS Condition

	ITU G.775 for E1 (Register LAC defaulted to '0')	ETSI 300 233 for E1 (Register LAC set to '1')	ANSI T1.231 for T1
AIS Detected	Less than 3 zeros contained in each of two consecutive 512-bit stream are received	Less than 3 zeros contained in a 512-bit stream are received	Less than 9 zeros contained in a 8192-bit stream (a ones density of 99.9% over a period of 5.3 ms) are received
AIS Cleared	3 or more zeros contained in each of two consecutive 512-bit stream are received	3 or more zeros contained in a 512-bit stream are received	9 or more zeros contained in a 8192-bit stream are received

Table-8 Error Detection

Hardware Mode					
Line Code	Pin CVn Reports				
AMI	Bipolar Violation				
B8ZS/ HDB3	Bipolar Violation + Code Violation				

Host Mode							
Line Code	Code CODVn in e-CODV CZERn in e-CZER Pin CVn Reports						
AMI	-	-	Bipolar Violation				
B8ZS/HDB3	0	0	Bipolar Violation + Code Violation				
	0	1	Bipolar Violation + Code Violation + Excessive Zeros				
	1	0	Bipolar Violation				
	1	1	Bipolar Violation + Excessive Zeros				

2.4.6.1 BPV DETECTION AND REPORTING IN AMI LINE CODING

AMI stands for Alternative Mark Inversion. It uses bipolar pulses to represent logical values. A logic 0 is represented by no symbol and a logic 1 by pulses of alternating polarity. In AMI line coding, marks

(pulses) are transmitted or received alternatively on tip and ring. If a mark (pulse) is transmitted or received in the same polarity as the prior mark (pulse), it is a bipolar violation.

Bipolar violation (BPV) is a non-zero signal element in an AMI signal that has the same polarity as the previous non-zero signal element.

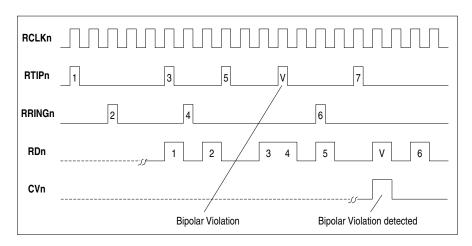


Figure-7 AMI Bipolar Violation

2.4.6.2 EXZ AND BPV DETECTION IN HDB3

The purpose of HDB3 is to prevent transmission of more than 3 consecutive zeros while maintaining DC balance. HDB3 encoder will encode any 4 consecutive zeros as 000V or B00V where V is a bipolar violation and B is a balancing pulse that is opposite in polarity to the previous V. If there is an odd number of B pulses since the last V, then the four consecutive zeros will be substituted as 000V. If there is an even number of B pulses since the last V, then B00V substitution is chosen. The HDB3 decoder, once receiving correctly encoded 000V or B00V, will automatically restore the pattern back into 4 consecutive zeros.

HDB3 decoder will report an EXZ (excessive zero) when it receives 4 consecutive zeros.

The detection of code violation in 000V, coded for 4 consecutive zeros in HDB3 line coding, depends on the number of alternate ones between two consecutive 'V' (code violation) in the input data pattern. If the number of alternate ones between two consecutive violations is an odd number, no violation detection is reported. In Figure-8 input pattern, there is one code violation detection for two 000V patterns. It can be inferred that in Figure-8, there is another code violation prior to the first 000V pattern, and the number of alternate pulses between these two violations is an odd number.

Conversely, if the number of alternate pulses between two violations is an even number, there is a code violation reported for 000V as in Figure-9.

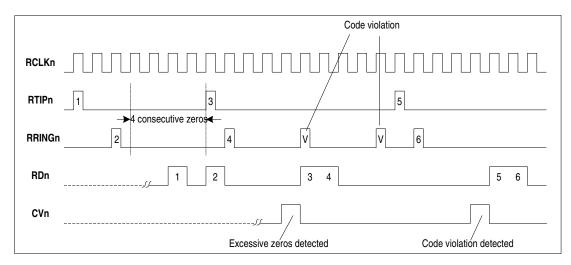


Figure-8 HDB3 Code Violation & Excessive Zeros

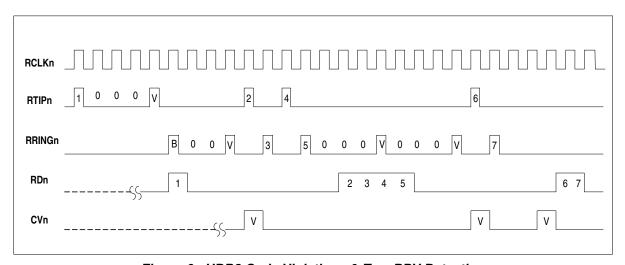


Figure-9 HDB3 Code Violations & Two BPV Detections

2.4.6.3 EXZ AND BPV DETECTION IN B8ZS

B8ZS (Binary 8 Zero Substitution) is an AMI line code with the substitution of a unique code to replace occurrences of eight consecutive zero signal elements. Each block of eight successive zeros is replaced by 000VB0VB, where B represents an inserted non-zero signal element, and V represents an inserted non-zero signal element that is a bipolar violation.

Bipolar violation (BPV) is a non-zero signal element that has the same polarity as the previous non-zero signal element. in normal B8ZS line coding for 8 contiguous zeros, two BPV signals are deliberately inserted. BPV in this case is not an error. Therefore, data and error

pulses will not appear on RDn and CVn pins in this BPV case. Sometimes, a BPV occurs as a result of transmission line noise or interference. As such, it is an error and should be detected and reported.

An excessive zeros (EXZ) for a B8ZS-coded signal is the occurrence of any zero-string length greater than seven contiguous zeros.

As shown in Figure-11, all three bipolar violations (pulse '2', '4' and '5') in the input data pattern are treated as individual code violations: they are recovered as data bits in RD signal line and a BPV is detected for each of the three violated pulses.

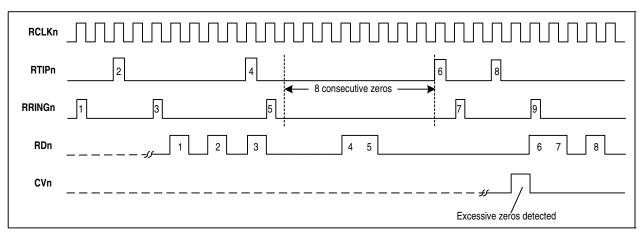


Figure-10 B8ZS Excessive Zeros

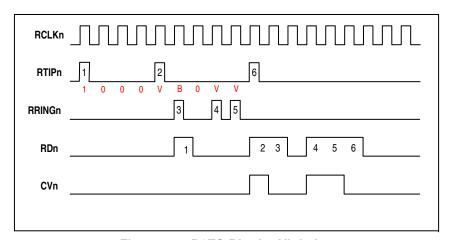


Figure-11 B8ZS Bipolar Violation

2.5 TRANSMITTER

In transmit path, data in NRZ format are clocked into the device on TDn and encoded by AMI or B8ZS/HDB3 line code rules when single rail mode is configured or pre-encoded data in NRZ format are input on TDPn and TDNn when dual rail mode is configured. The data are sampled into the device on falling edges of TCLKn. Jitter attenuator, if enabled, is provided with a FIFO through which the data to be transmitted are passing. A low jitter clock is generated by an integral digital phase-locked loop and is used to read data from the FIFO. The shape of the pulses are user programmable to ensure that the T1/E1 pulse template is met after the signal passes through different cable lengths or types. Bipolar violation, for diagnosis, can be inserted on pin BPVIn if AMI line code rule is enabled.

2.5.1 WAVEFORM SHAPER

T1 pulse template, specified in the DSX-1 Cross-Connect by ANSI T1.102, is illustrated in Figure-12. The device has built-in transmit waveform templates, corresponding to 5 levels of pre-equalization for cable of a length from 0 to 655 ft with each increment of 133 ft.

E1 pulse template, specified in ITU-T G.703, is shown in Figure-13. The device has built-in transmit waveform templates for cable of 75 Ω or 120 Ω .

Any one of the six built-in waveforms can be chosen in both hardware mode and host mode. In hardware mode, setting pins TS[2:0] can select the required waveform template for all the transmitters, as shown in Table-9. In host mode, the waveform template can be configured on a per-channel basis. Bits TSIA[2:0] in register **TSIA** are used to select the channel and bits TS[2:0] in register **TS** are used to select the required waveform template.

The built-in waveform shaper uses an internal high frequency clock which is 16XMCLK as the clock reference. This function will be bypassed when MCLK is unavailable.

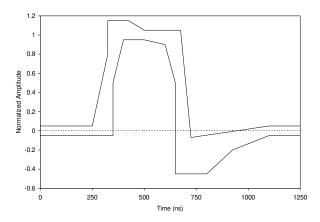


Figure-12 DSX-1 Waveform Template

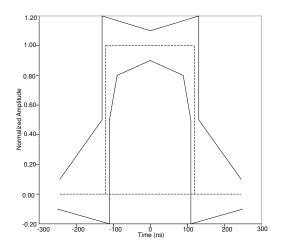


Figure-13 CEPT Waveform Template

Table-9 Built-in Waveform Template Selection

TS2	TS1	TS0	Service	Clock Rate	Cable Length	Maximum Cable Loss (dB) ⁽¹⁾		
0	0	0	E1	2.048 MHz	120 $\Omega/75$ Ω Cable	-		
-	-	•			1_0, 0 0	-		
0	0	1		Reserved				
0	1	0			Heserveu			
0	1	1	T1		0-133 ft. ABAM	0.6		
1	0	0			1.544 MHz	1.544 MHz	133-266 ft. ABAM	1.2
1	0	1		1.544 MHz			1.544 MHz	1.544 MHz
1	1	0			399-533 ft. ABAM	2.4		
1	1	1			533-655 ft. ABAM	3.0		

^{1.} Maximum cable loss at 772 kHz.

2.5.2 BIPOLAR VIOLATION INSERTION

When configured in Single Rail Mode 2 with AMI line code enabled, pin TDNn/BPVIn is used as BPVI input. A low-to-high transition on this pin inserts a bipolar violation on the next available mark in the transmit data stream. Sampling occurs on the falling edges of TCLK. But in TAOS (Transmit All Ones) with Analog Loopback, Remote Loopback and Inband Loopback, the BPVI is disabled. In TAOS with Digital Loopback, the BPVI is looped back to the system side, so the data to be transmitted on TTIPn and TRINGn are all ones with no bipolar violation.

2.6 JITTER ATTENUATOR

The jitter attenuator can be selected to work either in transmit path or in receive path or not used. The selection is accomplished by setting pin JAS in hardware mode or configuring bits JACF[1:0] in register **GCF** in host mode, which affects all eight channels.

For applications which require line synchronization, the line clock needed to be extracted for the internal synchronization, the jitter attenuator is set in the receive path. Another use of the jitter attenuator is to provide clock smoothing in the transmit path for applications such as synchronous/asynchronous demultiplexing applications. In these applications, TCLK will have an instantaneous frequency that is higher than the nominal T1/E1 data rate and in order to set the average long-term TCLK frequency within the transmit line rate specifications, periods of TCLK are suppressed (gapped).

The jitter attenuator integrates a FIFO which can accommodate a gapped TCLK. In host mode, the FIFO length can be 32 X 2 or 64 X 2 bits by programming bit JADP in **GCF**. In hardware mode, it is fixed to 64 X 2 bits. The FIFO length determines the maximum permissible gap width (see Table-10 Gap Width Limitation). Exceeding these values will cause FIFO overflow or underflow. The data is 16 or 32 bits' delay through the jitter attenuator in the corresponding transmit or receive path. The constant delay feature is crucial for the applications requiring "hitless" switching.

Table-10 Gap Width Limitation

FIFO Length	Max. Gap Width
64 bit	56 UI
32 bit	28 UI

In host mode, bit JABW in GCF determines the jitter attenuator 3 dB corner frequency (fc) for both T1 and E1. In hardware mode, the fc is fixed to 2.5 Hz for T1 or 1.7 Hz for E1. Generally, the lower the fc is, the higher the attenuation. However, lower fc comes at the expense of increased acquisition time. Therefore, the optimum fc is to optimize both the attenuation and the acquisition time. In addition, the longer FIFO length results in an increased throughput delay and also influences the 3 dB corner frequency. Generally, it's recommended to use the lower corner frequency and the shortest FIFO length that can still meet jitter attenuation requirements.

Table-11 Output Jitter Specification

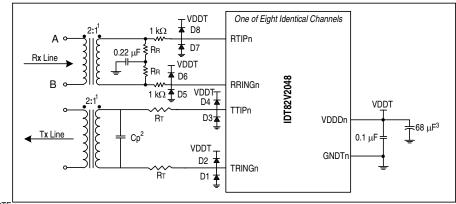
T1	E1
AT&T Pub 62411	ITU-T G.736
GR-253-CODE	ITU-T G.742
TR-TSY-000009	ITU-T G.783
111 101 00000	ETSI CTR 12/13

2.7 LINE INTERFACE CIRCUITRY

The transmit and receive interface RTIPn/RRINGn and TTIPn/TRINGn connections provide a matched interface to the cable. Figure-14 shows the appropriate external components to connect with the cable for one transmit/receive channel. Table-12 summarizes the component values based on the specific application.

Table-12 External Components Values

Component		T1	
Component	75 Ω Coax 120 Ω Twisted Pair		100 Ω Twisted Pair, VDDT = 5.0 V
$R_{\scriptscriptstyle T}$	9.5 Ω \pm 1%	$9.5~\Omega\pm1\%$ $9.5~\Omega\pm1\%$	
R_R	9.31 Ω \pm 1%	12.4 Ω \pm 1%	
Ср	22	1000 pF	
D1 - D4	Nihon Inter Electronics - EP05Q03L, 11EQS03L, EC10QS04, EC10QS03L; Motorola - MBR0540T1		



- NOTE:
- 1. Pulse T1124 transformer is recommended to be used in Standard (STD) operating temperature range (0°C to 70°C), while Pulse T1114 transformer is recommended to be used in Extended (EXT) operating temperature range is -40°C to +85°C. See Transformer Specifications Table for details
- 2. Typical value. Adjust for actual board parasitics to obtain optimum return loss.
- 3. Common decoupling capacitor for all VDDT and GNDT pins. One per chip.

Figure-14 External Transmit/Receive Line Circuitry

2.8 TRANSMIT DRIVER POWER SUPPLY

All transmit driver power supplies must be 5.0 V or 3.3 V.

In E1 mode, despite the power supply voltage, the 75 $\Omega/120~\Omega$ lines are driven through a pair of 9.5 Ω series resistors and a 1:2 transformer.

In T1 mode, only 5.0 V can be selected, 100 lines are driven through a pair of 9.1 Ω series resistors and a 1:2 transformer.

In harsh cable environment, series resistors are required to improve the transmit return loss performance and protect the device from surges coupling into the device.

Table-13 Transformer Specifications⁽¹⁾

	Electrical Specification @ 25°C									
Part	: No.	Turns Ratio (F	Pri: sec ± 2%)	OCL @ 25°0	C (mH MIN)	L _L (μΗ	MAX)	C _{w/w} (pl	MAX)	Package/Schematic
STD Temp.	EXT Temp.	Transmit	Receive	Transmit	Receive	Transmit	Receive	Transmit	Receive	1 dokago/conomatio
T1124	T1114	1:2CT	1CT:2	1.2	1.2	.6	.6	35	35	TOU/3

^{1.} Pulse T1124 transformer is recommended to be used in Standard (STD) operating temperature range (0°C to 70°C), while Pulse T1114 transformer is recommended to be used in Extended (EXT) operating temperature range is -40°C to +85°C.

2.9 POWER DRIVER FAILURE MONITOR

An internal power Driver Failure Monitor (DFMON), parallel connected with TTIPn and TRINGn, can detect short circuit failure between TTIPn and TRINGn pins. Bit SCPB in register **GCF** decides whether the output driver short circuit protection is enabled. When the short circuit protection is enabled, the driver output current is limited to a typical value: 180 mAp. Also, register **DF**, **DFI** and **DFM** will be available. When DFMON will detect a short circuit, register **DF** will be set. With a short circuit failure detected and short circuit protection enabled, register **DFI** will be set and an interrupt will be generated on pin $\overline{\text{INT}}$.

2.10 TRANSMIT LINE SIDE SHORT CIRCUIT FAILURE DETECTION

In E1 or T1 with 5 V VDDT, a pair of 9.5 Ω serial resistors connect with TTIPn and TRINGn pins and limit the output current. In this case, the output current is a limited value which is always lower than the typical line short circuit current 180 mAp, even if the transmit line side is shorted.

Refer to Table-12 External Components Values for details.

2.11 LINE PROTECTION

In transmit side, the Schottky diodes D1~D4 are required to protect the line driver and improve the design robustness. In receive side, the series resistors of 1 k Ω are used to protect the receiver against current surges coupled in the device. The series resistors do not affect the receiver sensitivity, since the receiver impedance is as high as 120 k Ω typically.

2.12 HITLESS PROTECTION SWITCHING (HPS)

The IDT82V2048 transceivers include an output driver with high-Z feature for T1/E1 redundancy applications. This feature reduces the cost of redundancy protection by eliminating external relays. Details of HPS are described in relative Application Note.

2.13 SOFTWARE RESET

Writing register **RS** will cause software reset by initiating about 1 μs reset cycle. This operation set all the registers to their default value.

2.14 POWER ON RESET

During power up, an internal reset signal sets all the registers to default values. The power-on reset takes at least 10 μ s, starting from when the power supply exceeds 2/3 VDDA.

2.15 POWER DOWN

Each transmit channel will be powered down by pulling pin TCLKn low for more than 64 MCLK cycles (if MCLK is available) or about 30 μ s (if MCLK is not available). In host mode, each transmit channel will also be powered down by setting bit TPDNn in register **e-TPDN** to '1'.

All the receivers will be powered down when MCLK is low. When MCLK is clocked or high, setting bit RPDNn in register **e-RPDN** to '1' will configure the corresponding receiver to be powered down.

2.16 INTERFACE WITH 5 V LOGIC

The IDT82V2048 can interface directly with 5 V TTL family devices. The internal input pads are tolerant to 5 V output from TTL and CMOS family devices.

2.17 LOOPBACK MODE

The device provides five different diagnostic loopback configurations: Digital Loopback, Analog Loopback, Remote Loopback, Dual Loopback and Inband Loopback. In host mode, these functions are implemented by programming the registers **DLB**, **ALB**, **RLB** and Inband Loopback register group respectively. In hardware mode, only Analog Loopback and Remote Loopback can be selected by pin LPn.

2.17.1 DIGITAL LOOPBACK

By programming the bits of register **DLB**, each channel of the device can be configured in Local Digital Loopback. In this configuration, the data and clock to be transmitted, after passing the encoder, are looped back to Jitter Attenuator (if enabled) and decoder in the receive path, then output on RCLKn, RDn/RDPn and CVn/RDNn. The data to be transmitted are still output on TTIPn and TRINGn while the data received on RTIPn and RRINGn are ignored. The Loss Detector is still in use. Figure-15 shows the process.

During Digital Loopback, the received signal on the receive line is still monitored by the LOS Detector (See 2.4.4 Loss of Signal (LOS) Detection for details). In case of a LOS condition and AIS insertion enabled, all ones signal will be output on RDPn/RDNn. With ATAO enabled, all ones signal will be also output on TTIPn/TRINGn. AIS insertion can be enabled by setting AISE bit in register **GCF** and ATAO can be enabled by setting register **ATAO** (default disabled).

2.17.2 ANALOG LOOPBACK

By programming the bits of register **ALB** or pulling pin LPn high, each channel of the device can be configured in Analog Loopback. In this configuration, the data to be transmitted output from the line driver are internally looped back to the slicer and peak detector in the receive path and output on RCLKn, RDn/RDPn and CVn/RDNn. The data to be transmitted are still output on TTIPn and TRINGn while the data received on RTIPn and RRINGn are ignored. The LOS Detector (See 2.4.4 Loss of Signal (LOS) Detection for details) is still in use and monitors the internal looped back data. If a LOS condition on TDPn/TDNn is expected during Analog Loopback, ATAO should be disabled (default). Figure-16 shows the process.

The TTIPn and RTIPn, TRINGn and RRINGn cannot be connected directly to do the external analog loopback test. Line impedance loading is required to conduct the external analog loopback test.

2.17.3 REMOTE LOOPBACK

By programming the bits of register **RLB** or pulling pin LPn low, each channel of the device can be set in Remote Loopback. In this configuration, the data and clock recovered by the clock and data recovery circuits are looped to waveform shaper and output on TTIPn and TRINGn. The jitter attenuator is also included in loopback when enabled in the transmit or receive path. The received data and clock are still output on RCLKn, RDn/RDPn and CVn/RDNn while the data to be transmitted on TCLKn, TDn/TDPn and BPVIn/TDNn are ignored. The LOs Detector is still in use. Figure-17 shows the process.

2.17.4 DUAL LOOPBACK

Dual Loopback mode is set by setting bit DLBn in register **DLB** and bit RLBn in register **RLB** to '1'. In this configuration, after passing the encoder, the data and clock to be transmitted are looped back to decoder directly and output on RCLKn, RDn/RDPn and CVn/RDNn. The recovered data from RTIPn and RRINGn are looped back to waveform shaper through JA (if selected) and output on TTIPn and TRINGn. The LOS Detector is still in use. Figure-18 shows the process.

2.17.5 TRANSMIT ALL ONES (TAOS)

In hardware mode, the TAOS mode is set by pulling pin TCLKn high for more than 16 MCLK cycles. In host mode, TAOS mode is set by programming register **TAO**. In addition, automatic TAOS signals are inserted by setting register **ATAO** when Loss of Signal occurs. Note that the TAOS generator adopts MCLK as a timing reference. In order to assure that the output frequency is within specified limits, MCLK must have the applicable stability.

The TAOS mode, the TAOS mode with Digital Loopback and the TAOS mode with Analog Loopback are shown in Figure-19, Figure-20 and Figure-21.

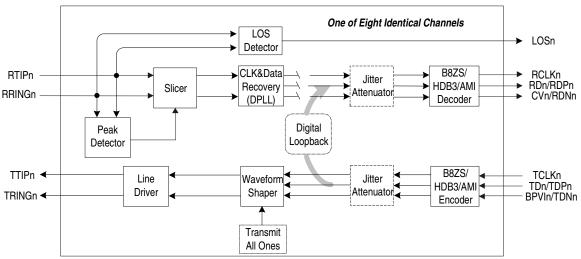


Figure-15 Digital Loopback

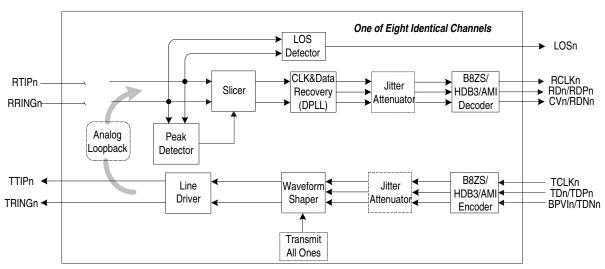


Figure-16 Analog Loopback

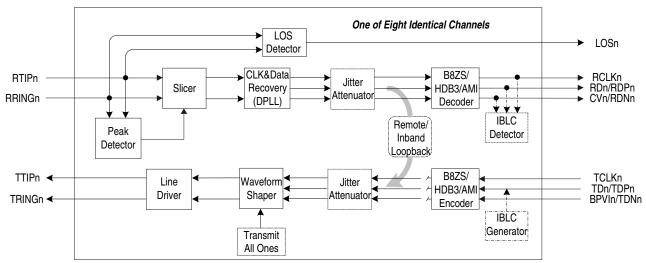


Figure-17 Remote Loopback

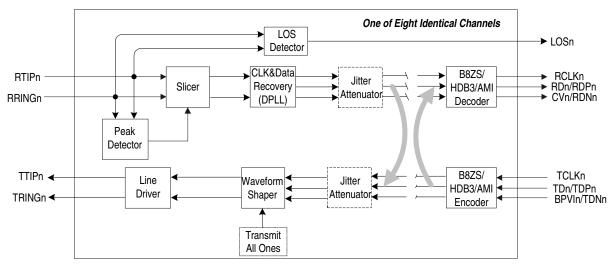


Figure-18 Dual Loopback

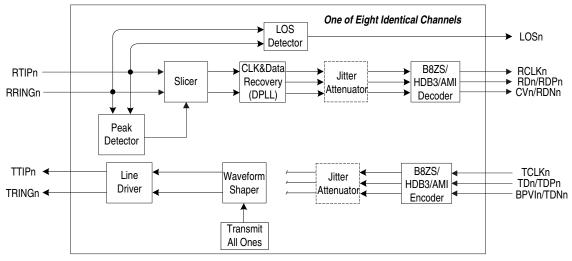


Figure-19 TAOS Data Path

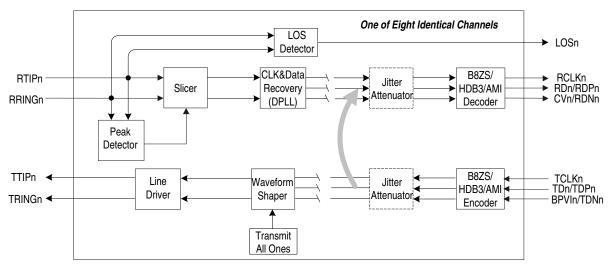


Figure-20 TAOS with Digital Loopback

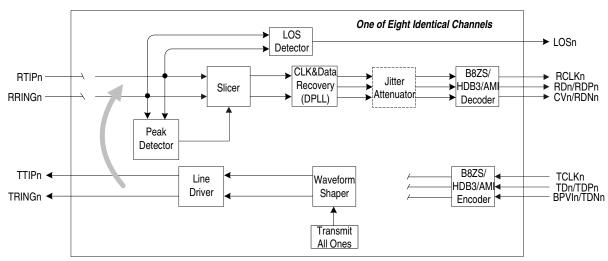


Figure-21 TAOS with Analog Loopback

2.17.6 INBAND LOOPBACK

Inband Loopback is a function that facilitates the system remote diagnosis. When this function is enabled, the chip will detect or generate the Inband Loopback Code. There are two kinds of Inband Loopback Code: Activate Code and Deactivate Code. If the Activate Code is received from the far end in a continuous 5.1 second, the chip will automatically go into Remote Loopback Mode (shown in Figure-17). If the Deactivate Code is received from the far end in a continuous 5.1 second, the chip quits from the Remote Loopback mode. The chip can send the Activate Code and Deactivate Code to the far end. Two function blocks: IBLC Detector (Inband Loopback Code Detector) and IBLC Generator (Inband Loopback Code Generator), realize the Inband Loopback.

The detection of Inband Loopback Code is enabled by bit LBDE in register **e-LBCF**. If bit ALBE in register **e-LBCF** is set to '1', the chip will automatically go into or quit from the Remote Loopback mode based on the receipt of Inband Loopback Code. The length of the Activate Code is defined in bits LBAL[1:0] in register **e-LBCF**; and the length of the Deactivate Code is defined in bits LBDL[1:0] in register **e-LBCF**. The pattern

of the Activate Code is defined in register **e-LBAC**, and the pattern of the Deactivate Code is defined in register **e-LBDC**. The above settings are globally effective for all the eight channels. The presence of Inband Loopback Code in each channel is reflected timely in register **e-LBS**. Any transition of each bit in register **e-LBM** will be reflected in register **e-LBI**, and if enabled in register **e-LBM**, will generate an interrupt. The required sequence of programming the Inband Loopback Code detection is: First, set registers **e-LBAC** and **e-LBDC**, followed by register **e-LBM**. Finally, to activate Inband Loopback detection, set register **e-LBCF**.

The Inband Loopback Code Generator use the same registers as the Inband Loopback Detector to define the length and pattern of Activate Code and Deactivate Code. The length and pattern of the generated Activate Code and Deactivate Code can be different from the detected Activate Code and Deactivate Code. Register e-LBGS determines sending Activate Code or Deactivate Code, and register e-LBGE acts as a switch to start or stop the sending of Inband Loopback Code to the selected channels. Before sending Inband Loopback Code, users should be sure that registers e-LBCF, e-LBAC, e-LBDC and e-LBSG

are configured properly. The required sequence for configuring the Inband Loopback Generator is: First, set registers **e-LBAC** and **e-LBDC**, followed by register **e-LBCF**. Then, to select the Inband Loopback generator set registers **e-LBGS** and then **e-LBGE**.

The Inband Loopback Detection and the Inband Loopback Generation can not be used simultaneously.

Example: 5-bit Loop-up/Loop-down Detection (w/o interrupts):

(see note in register description for e-LBAC)

Loop-up code: 11000 Loop-down code: 11100

Set (in this order)

e-LBAC (0x09) = 0xC6 (11000110) e-LBDC (0x0A) = 0xE7 (11100111)

e-LBCF (0x08) = 0x30

Example: 5-bit Loop-up/Loop-down Activation on Channel 1 (w/o interrupts):

Loop-up code: 11000

Loop-down code: 11100 Set (in this order)

e-LBAC(0x09) = 0xC6(11000110)

e-LBDC (0x0A) = 0xE7 (11100111) e-LBCF (0x08) = 0x00 e-LBGS (0x0E) = 0x00 e-LBGE (0x0F) = 0x02

2.18 HOST INTERFACE

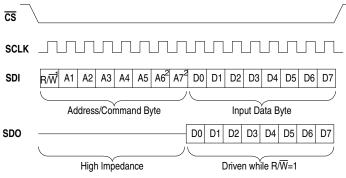
The host interface provides access to read and write the registers in the device. The interface consists of serial host interface and parallel host interface. By pulling pin MODE2 to VDDIO/2 or high, the device can be set to work in serial mode and in parallel mode respectively.

2.18.1 PARALLEL HOST INTERFACE

The interface is compatible with Motorola and Intel host. Pins MODE1 and MODE0 are used to select the operating mode of the parallel host interface. When pin MODE1 is pulled low, the host uses separate address bus and data bus. When high, multiplexed address/data bus is used. When pin MODE0 is pulled low, the parallel host interface is configured for Motorola compatible hosts. When pin MODE0 is pulled high, the parallel host interface is configured for Intel compatible hosts. See Table-1 Pin Description for more details. The host interface pins in each operation mode is tabulated in Table-14:

Table-14 Parallel Host Interface Pins

MODE[2:0]	Host Interface	Generic Control, Data and Output Pin
100	Non-multiplexed Motorola interface	$\overline{\text{CS}}$, $\overline{\text{ACK}}$, $\overline{\text{DS}}$, $\overline{\text{R/W}}$, $\overline{\text{AS}}$, A[4:0], D[7:0], $\overline{\text{INT}}$
101	Non-multiplexed Intel interface	CS, RDY, WR, RD, ALE, A[4:0], D[7:0], INT
110	Multiplexed Motorola interface	CS, ACK, DS, R/W, AS, AD[7:0], INT
111	Multiplexed Intel interface	CS, RDY, WR, RD, ALE, AD[7:0], INT



- 1. While R/W=1, read from IDT82V2048; While R/W=0, write to IDT82V2048.
- 2. Ignored.

Figure-22 Serial Host Mode Timing

2.18.2 SERIAL HOST INTERFACE

By pulling pin MODE2 to VDDIO/2, the device operates in the serial host Mode. In this mode, the registers are accessible through a 16-bit word which contains an 8-bit command/address byte (bit R/\overline{W} and 5-address-bit A1~A5, A6 and A7 bits are ignored) and a subsequent 8-bit

data byte (D7~D0), as shown in Figure-22. When bit R/ \overline{W} is set to '1', data is read out from pin SDO. When bit R/ \overline{W} is set to '0', data on pin SDI is written into the register whose address is indicated by address bits A5~A1. See Figure-22 Serial Host Mode Timing.